SDAS224B - JUNE 1982 - REVISED NOVEMBER 1995

- Compare Two 8-Bit Words
- Choice of Totem-Pole or Open-Collector Outputs
- SN74ALS518 and 'ALS520 Have 20-kΩ
 Pullup Resistors on Q Inputs
- Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

TYPE	INPUT PULLUP RESISTOR	OUTPUT FUNCTION AND CONFIGURATION
SN74ALS518	Yes	P = Q open collector
'ALS520	Yes	$\overline{P} = Q$ totem pole
SN74ALS521 [‡]	No	$\overline{P} = Q$ totem pole

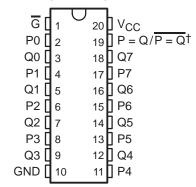
‡SN74ALS521 is identical to 'ALS688

description

These identity comparators perform comparisons on two 8-bit binary or BCD words. The SN74ALS518 provides P=Q outputs, while the 'ALS520' and SN74ALS521 provide $\overline{P}=\overline{Q}$ outputs. The SN74ALS518 has an open-collector output. The SN74ALS518 and 'ALS520' feature 20-k Ω pullup resistors on the Q inputs for analog or switch data.

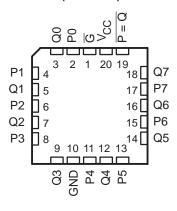
The SN54ALS520 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ALS518, SN74ALS520, and SN74ALS521 are characterized for operation from 0°C to 70°C.

SN54ALS520 . . . J PACKAGE SN74ALS518, SN74ALS520, SN74ALS521 . . . DW OR N PACKAGE (TOP VIEW)



 † P = Q for SN74ALS518 P = Q for 'ALS520 and SN74ALS521

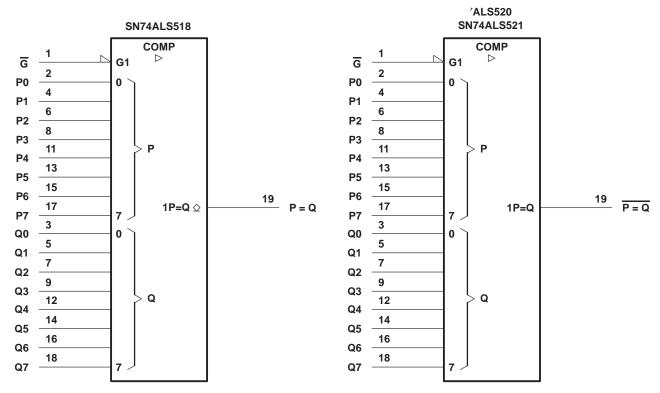
SN54ALS520 . . . FK PACKAGE (TOP VIEW)



FUNCTION TABLE

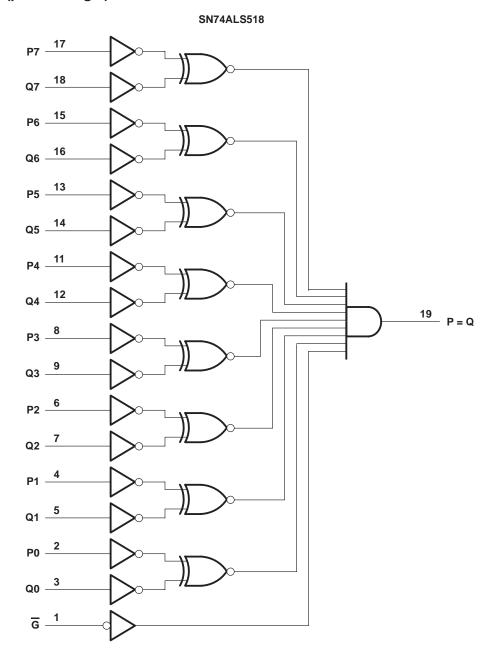
IN	PUTS	OUTPUTS				
DATA P, Q	ENABLE G	P = Q	P = Q			
P = Q	L	Н	L			
P > Q	L	L	Н			
P < Q	L	L	Н			
Х	Н	L	Н			

logic symbols†

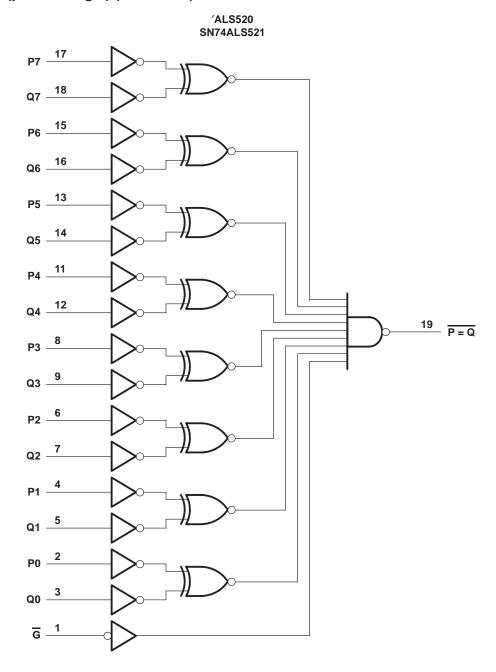


† These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagrams (positive logic)



logic diagrams (positive logic) (continued)





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC}	7 V
Input voltage, V _I : Q inputs	V _{CC} + 0.5 V or 5.5 V, whichever is less
All other inputs	7 V
Off-state output voltage	
Operating free-air temperature range, T _A : SN74ALS518	0°C to 70°C
Storage temperature range	

recommended operating conditions

		SN	74ALS5	18	UNIT
		MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2			V
V_{IL}	Low-level input voltage			0.8	V
Vон	High-level output voltage			5.5	V
loL	Low-level output current			24	mA
TA	Operating free-air temperature	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	DADAMETED	TEST COM	TEST CONDITIONS					
	PARAMETER	TEST CONI						
٧ıK		V _{CC} = 4.5 V,	$I_{I} = -18 \text{ mA}$			-1.5	V	
loh		V _{CC} = 5.5 V,	V _{OH} = 5.5 V			0.1	mA	
V/01		V00 - 45 V	I _{OL} = 12 mA		0.25	0.4	V	
VOL		V _{CC} = 4.5 V	$I_{OL} = 24 \text{ mA}$		0.35	0.5	V	
1.	Q inputs	V00 - 5 5 V	V _I = 5.5 V			0.1	mA	
1 ₁	All other inputs	V _{CC} = 5.5 V	V _I = 7 V			0.1	IIIA	
la c	Q inputs	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	V 0.7V			-0.2	mA	
¹IН	All other inputs	V _{CC} = 5.5 V,	V _I = 2.7 V			20	μΑ	
Lin	Q inputs	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	V _I = 0.4 V			-0.6	mA	
IIL	All other inputs	V _{CC} = 5.5 V,	V = 0.4 V			-0.1	IIIA	
Icc		V _{CC} = 5.5 V,	See Note 1		11	17	mA	

‡ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25 ^{\circ}\text{C}$.

NOTE 1: ICC is measured with G grounded, and P and Q at 4.5 V.



[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

SN54ALS520, SN74ALS518, SN74ALS520, SN74ALS521 8-BIT IDENTITY COMPARATORS

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switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 4.5 C _L = 50 pF R _L = 680 Ω T _A = MIN to SN74A	o MAX†	UNIT
t _{PLH}	D or O	р. О	15	33	nc
t _{PHL}	P or Q	P = Q	3	15	ns
t _{PLH}	G	P = Q	15	33	ns
^t PHL	0	1 – 4	3	15	115

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V _{CC}	7 V
Input voltage, V _I : Q inputs of 'ALS520 V _{CC} + 0.5 V or 5.5 V, wh	nichever is less
All other inputs	7 V
Operating free-air temperature range, T _A : SN54ALS520 –	·55°C to 125°C
SN74ALS520, SN74ALS521	. 0°C to 70°C
Storage temperature range –	·65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN	54ALS5	20	_	74ALS5 74ALS5	-	UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Vcc	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.7			0.8	V
ІОН	High-level output current			-1			-2.6	mA
loL	Low-level output current			12			24	mA
TA	Operating free-air temperature	-55		125	0		70	°C

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST COI	TEST CONDITIONS			20		74ALS5 74ALS5		UNIT	
					TYP [†]	MAX	MIN	TYP [†]	MAX		
٧ıK		V _{CC} = 4.5 V,	$I_{I} = -18 \text{ mA}$			-1.5			-1.5	V	
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2	2		V _{CC} -2	2			
Vон		V45V	I _{OH} = - 1 mA	2.4	3.3					V	
		V _{CC} = 4.5 V	$I_{OH} = -2.6 \text{ mA}$				2.4	3.2			
V/01		V00 - 45 V	I _{OL} = 12 mA		0.25	0.4		0.25	0.4	V	
VOL		VCC = 4.5 V	I _{OL} = 24 mA					0.35	0.5	V V	
ı.	'ALS520 Q inputs	V00 - 5 5 V	V _I = 5.5 V			0.1			0.1	mA	
11	All other inputs	VCC = 5.5 V	V _I = 7 V			0.1			0.1	mA	
	'ALS520 Q inputs	V 55V	V- 2.7.V			-0.2			-0.2	mA	
lіН	All other inputs	$V_{CC} = 5.5 \text{ V},$	$V_1 = 2.7 \text{ V}$			20			20	μΑ	
	'ALS520 Q inputs	V 55V	V: 0.4.V			-0.6			-0.6	A	
IIL.	All other inputs	V _{CC} = 5.5 V,	$V_{ } = 0.4 \text{ V}$			-0.1			-0.1	mA	
10 [‡]		V _{CC} = 5.5 V,	V _O = 2.25 V	-20		-112	-30		-112	mA	
	'ALS520				12	19		12	19	A	
ICC SN74ALS521		V _{CC} = 5.5 V,	See Note 1		12	19		12	19	mA	

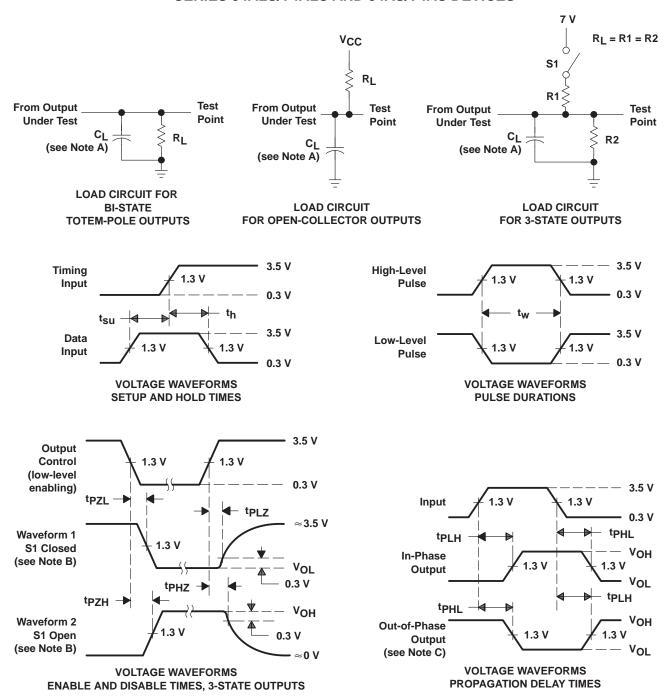
switching characteristics (see Figure 1)

PARAMETER	FROM	то	V _C C _L R _L T _A	C = 4.5 = 50 pl = 500 g	V to 5.5 =, 2, to MAX§	V,	UNIT
	(INPUT)	(OUTPUT)	SN54A	LS520	SN74A SN74A		
			MIN	MAX	MIN	MAX	
^t PLH	D an O	<u> </u>	3	19	3	12	no
t _{PHL}	P or Q	$\overline{P} = Q$	3	25	5	20	ns
t _{PLH}	G	P = Q	2	18	2	12	ns
t _{PHL}	9	1 = Q	5	23	5	22	115

[§] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C. ‡ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, los. NOTE 1: I_{CC} is measured with \overline{G} grounded, and P and Q at 4.5 V.

PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, $t_f = t_f = 2$ ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
5962-88691012A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962- 88691012A SNJ54ALS 520FK	Samples
5962-8869101RA	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8869101RA SNJ54ALS520J	Samples
SN54ALS520J	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54ALS520J	Samples
SN74ALS518DW	ACTIVE	SOIC	DW	20	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS518	Samples
SN74ALS518DWE4	ACTIVE	SOIC	DW	20	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS518	Samples
SN74ALS518N	ACTIVE	PDIP	N	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS518N	Samples
SN74ALS520DW	ACTIVE	SOIC	DW	20	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS520	Samples
SN74ALS520N	ACTIVE	PDIP	N	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS520N	Samples
SN74ALS520NSR	ACTIVE	so	NS	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS520	Samples
SN74ALS521DW	ACTIVE	SOIC	DW	20	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS521	Samples
SN74ALS521DWR	ACTIVE	SOIC	DW	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS521	Samples
SN74ALS521N	ACTIVE	PDIP	N	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS521N	Samples
SN74ALS521NSR	ACTIVE	SO	NS	20	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS521	Samples
SNJ54ALS520FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962- 88691012A SNJ54ALS 520FK	Samples
SNJ54ALS520J	ACTIVE	CDIP	J	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-8869101RA SNJ54ALS520J	Samples

⁽¹⁾ The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

PACKAGE OPTION ADDENDUM

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LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54ALS520, SN74ALS520:

Catalog: SN74ALS520

Military: SN54ALS520

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

PACKAGE OPTION ADDENDUM

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• Military - QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

All difficultions are norminal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS520NSR	SO	NS	20	2000	330.0	24.4	8.4	13.0	2.5	12.0	24.0	Q1
SN74ALS521DWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
SN74ALS521NSR	SO	NS	20	2000	330.0	24.4	8.4	13.0	2.5	12.0	24.0	Q1

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*All dimensions are nominal

7 th difficition and from that							
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALS520NSR	SO	NS	20	2000	367.0	367.0	45.0
SN74ALS521DWR	SOIC	DW	20	2000	367.0	367.0	45.0
SN74ALS521NSR	SO	NS	20	2000	367.0	367.0	45.0

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

all difficultions are norminal								
Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
5962-88691012A	FK	LCCC	20	1	506.98	12.06	2030	NA
SN74ALS518DW	DW	SOIC	20	25	507	12.83	5080	6.6
SN74ALS518DWE4	DW	SOIC	20	25	507	12.83	5080	6.6
SN74ALS518N	N	PDIP	20	20	506	13.97	11230	4.32
SN74ALS520DW	DW	SOIC	20	25	507	12.83	5080	6.6
SN74ALS520N	N	PDIP	20	20	506	13.97	11230	4.32
SN74ALS521DW	DW	SOIC	20	25	507	12.83	5080	6.6
SN74ALS521N	N	PDIP	20	20	506	13.97	11230	4.32
SNJ54ALS520FK	FK	LCCC	20	1	506.98	12.06	2030	NA

14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.





SOIC



- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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